

2SK1517, 2SK1518 Silicon N Channel MOS FET

REJ03G0947-0200 (Previous: ADE-208-1287) Rev.2.00 Sep 07, 2005

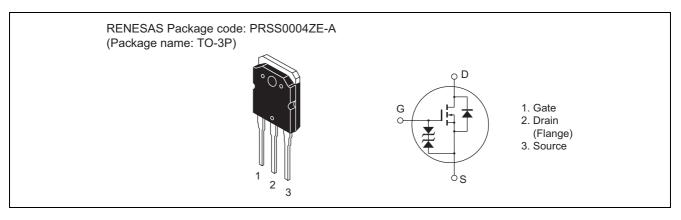
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 120 \text{ ns}$)
- Suitable for motor control, switching regulator, DC-DC converter

Outline





Absolute Maximum Ratings

| | | | $(Ta = 25^{\circ}C)$ | |
|---|--------------------|--|--|--|
| Item | | Ratings | Unit | |
| 2SK1517 | V _{DSS} | 450 | V | |
| 2SK1518 | | 500 | | |
| Gate to source voltage | | ±30 | V | |
| Drain current | | 20 | А | |
| Drain peak current | | 80 | А | |
| Body to drain diode reverse drain current | | 20 | А | |
| Channel dissipation | | 120 | W | |
| | Tch | 150 | °C | |
| | Tstg | -55 to +150 | °C | |
| | 2SK1517 2SK1518 | 2SK1517 VDSS 2SK1518 VGSS ID ID ID(pulse) ID e drain current IDR Pch*2 Tch | $\begin{tabular}{ c c c c c c c } \hline 2SK1517 & V_{DSS} & 450 \\ \hline 2SK1518 & 500 \\ \hline & V_{GSS} & \pm 30 \\ \hline & I_D & 20 \\ \hline & I_{D(pulse)}^{-1} & 80 \\ \hline & drain current & I_{DR} & 20 \\ \hline & Pch_{2} & 120 \\ \hline & Tch & 150 \\ \hline \end{tabular}$ | |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25^{\circ}C$

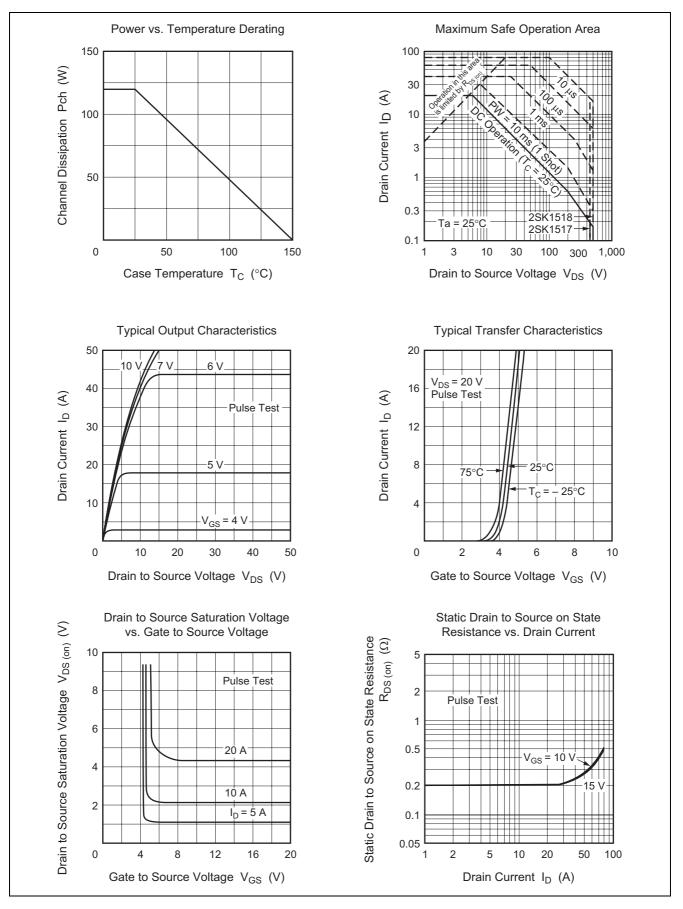
Electrical Characteristics

| | | | | | | | $(Ta = 25^{\circ}C)$ |
|--------------------------------------|---------|----------------------|-----|------|------|------|--|
| Item | | Symbol | Min | Тур | Max | Unit | Test conditions |
| Drain to source | 2SK1517 | V _{(BR)DSS} | 450 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| breakdown voltage | 2SK1518 | | 500 | | | | |
| Gate to source breakdown voltage | | V _{(BR)GSS} | ±30 | — | — | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | | I _{GSS} | _ | — | ±10 | μΑ | $V_{GS} = \pm 25 V, V_{DS} = 0$ |
| Zero gate voltage drain | 2SK1517 | I _{DSS} | _ | — | 250 | μΑ | $V_{DS} = 360 \text{ V}, V_{GS} = 0$ |
| current | 2SK1518 | | | | | | $V_{DS} = 400 V, V_{GS} = 0$ |
| Gate to source cutoff voltage | | V _{GS(off)} | 2.0 | _ | 3.0 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$ |
| Static drain to source on | 2SK1517 | R _{DS(on)} | _ | 0.20 | 0.25 | Ω | $I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$ |
| state resistance | 2SK1518 | 1 | _ | 0.22 | 0.27 | | |
| Forward transfer admittance | | y _{fs} | 10 | 16 | — | S | $I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$ |
| Input capacitance | | Ciss | _ | 3050 | — | pF | $V_{DS} = 10 V, V_{GS} = 0,$ |
| Output capacitance | | Coss | _ | 940 | — | pF | f = 1 MHz |
| Reverse transfer capacitance | | Crss | _ | 140 | — | pF | 7 |
| Turn-on delay time | | t _{d(on)} | _ | 35 | — | ns | $I_D = 10 \text{ A}, V_{GS} = 10 \text{ V},$ |
| Rise time | | tr | _ | 130 | — | ns | $R_L = 3 \Omega$ |
| Turn-off delay time | | t _{d(off)} | _ | 240 | — | ns | 7 |
| Fall time | | t _f | _ | 105 | — | ns | 7 |
| Body to drain diode forward voltage | | V _{DF} | _ | 1.0 | | V | $I_F = 20 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse recovery | | t _{rr} | _ | 120 | _ | ns | $I_F = 20 \text{ A}, V_{GS} = 0,$ |
| time | | | | | | | di _F /dt = 100 A/µs |

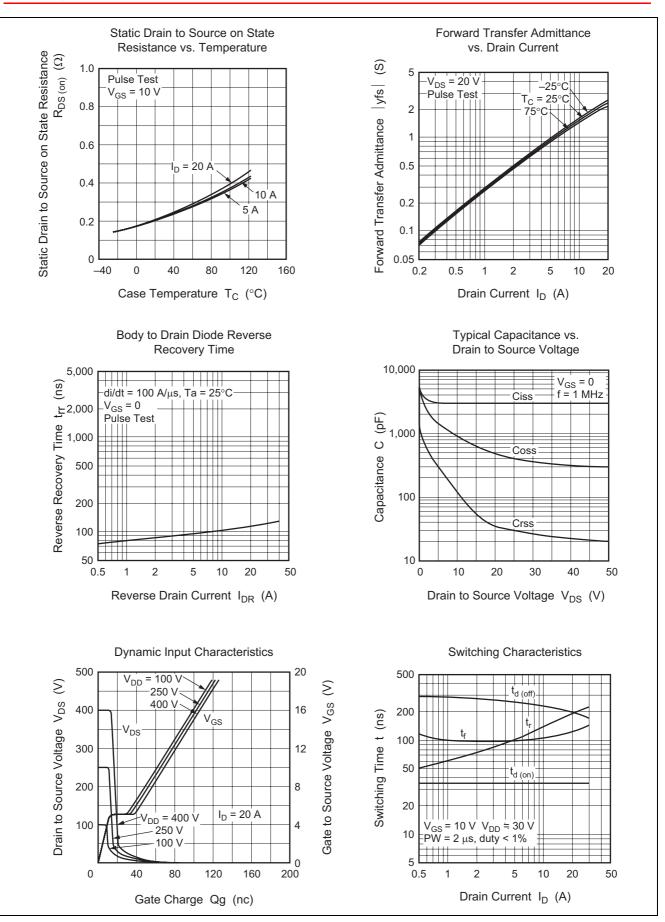
Note: 3. Pulse test



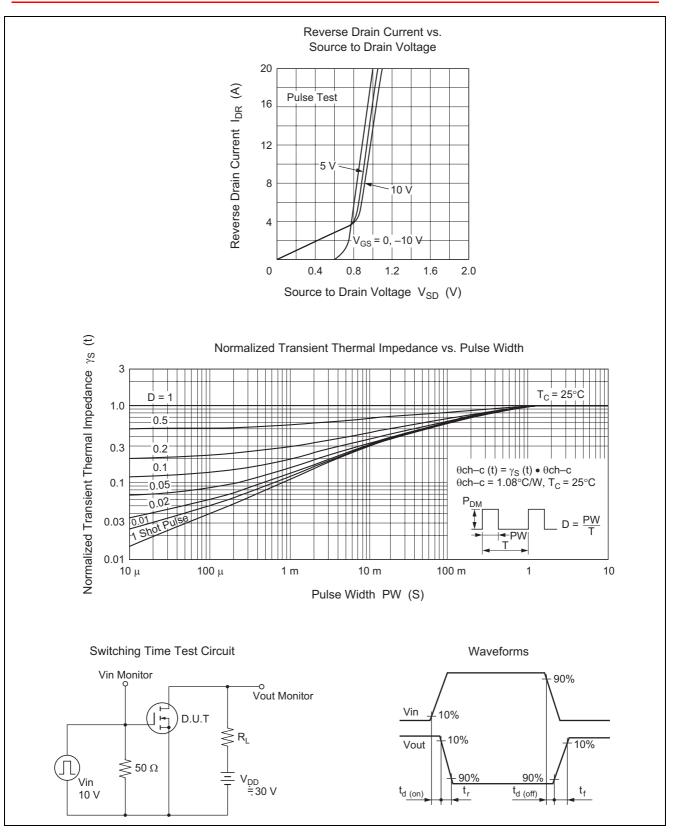
Main Characteristics



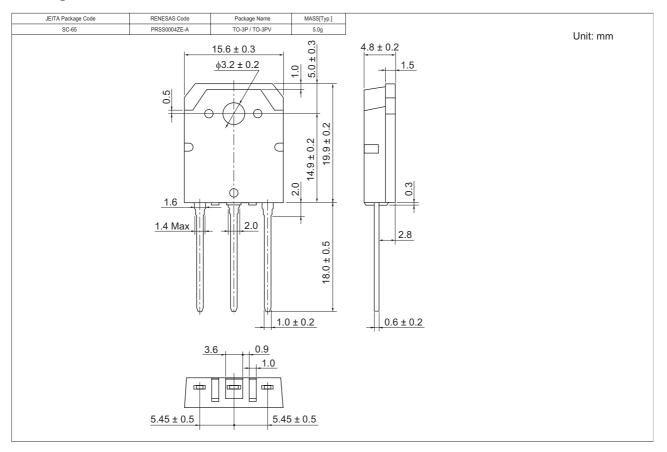








Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK1517-E | 360 pcs | Box (Tube) |
| 2SK1518-E | 360 pcs | Box (Tube) |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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